Electronic Patent Application Fee Transmittal							
Application Number:	105	10599440					
Filing Date:	28-	28-5ep-2006					
Title of Invention:		SILICON ELECTRODE PLATE FOR PLASMA ETCHING WITH SUPERIOR DURABILITY					
First Named Inventor/Applicant Name:	Hic	Hideki Fujiwara					
Filer:	Me	Melvin C. Garner/Alma D. Clemena					
Attorney Docket Number:	692	6920/1106-US0					
Filed as Large Entity	•						
U.S. National Stage under 35 USC 371 Fil	ing Fee	5					
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)		
Basic Filing:				•	,		
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Claims:							
Miscellaneous-Filing:							
Petition:							
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